Processor SDK Linux HS Support



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This page captures the specific instructions for running Processor SDK Linux Automotive on DRA7xx HS devices as an addendum to Processor SDK Linux Automotive Software
Developers Guide (http://processors.wiki.ti.com/index.php/Processor_SDK_Linux_Automotive_Software_Developers_Guide).

Contents

Prerequisites

EVM Hardware TI SECDEV Software

Build SDK images for HS

OP-TEE Trusted execution environment

Testing OP-TEE

Prerequisites

EVM Hardware

J6 HS EVM revisions G or H, or J6 ECO HS EVM revisions B or C is required.

TI SECDEV Software

TI SECDEV software package, version 4.6.0 is required to build boot images for HS EVMs. To obtain TI SECDEV package, please contact a TI representative.

 $\textbf{Step 1:} \ \textbf{Select or create a directory on the development host for SECDEV installation}.$

 $\textbf{Step 2:} \ \textbf{Export the environment variable TI_SECURE_DEV_PKG_AUTO to point to this path.}$

Step 3: Create a directory called "dra7" here and extract the contents of the SECDEV package.

In summary, the contents of the SECDEV package must be available at \$TI_SECURE_DEV_PKG_AUTO/dra7 for building boot images for HS devices.

Build SDK images for HS

Yocto system is used to build SDK images for HS devices. Follow the process as documented in the SDG (http://processors.wiki.ti.com/index.php/Processor_SDK_Linux_Automotive_S oftware_Developers_Guide#Building_Yocto_Filesystem), stop before this running this command.

host \$./build-core-sdk.sh dra7xx-evm

For J6 Rev. G EVM, there are two patches that are required

Apply the following patch to meta-glsdk, at yocto-layers/sources/meta-glsdk

 $1.\ 0001-u-boot-ti-staging-Changes-for-HS-boot-in-Rev-G.patch\ (http://processors.wiki.ti.com/images/8/83/0001-u-boot-ti-staging-Changes-for-HS-boot-in-Rev-G.patch\ (http://processors.wiki.ti.com/images/8/83/0001-u-boot-ti-staging-ti-staging-ti-staging-ti-staging-ti-staging-ti-staging-ti-staging-ti-staging-ti$

Apply the following patch to meta-arago, at yocto-layers/sources/meta-arago

 $2.\ \underline{0001\text{-}optee\text{-}os\text{-}Add\text{-}patch\text{-}for\text{-}Rev\text{-}G\text{-}support\text{.}patch\ (http://processors.wiki.ti.com/images/2/2b/0001\text{-}optee\text{-}os\text{-}Add\text{-}patch\text{-}for\text{-}Rev\text{-}G\text{-}support\text{.}patch.gz)}$

For J6 ECO Rev. B EVM, apply the following patch to meta-glsdk, at yocto-layers/sources/meta-glsdk

 $1.\ 0001-u-boot-ti-staging-Changes-for-HS-boot-in-Rev-G.patch\ (http://processors.wiki.ti.com/images/8/83/0001-u-boot-ti-staging-Changes-for-HS-boot-in-Rev-G.patch.gz)$

For J6 Rev. H EVM and For J6 ECO Rev. C EVM no patches are required.

Now, run the command below. Note that the machine name must be given as **dra7xx-hs-evm** for HS devices.

host \$./build-core-sdk.sh dra7xx-hs-evm

 $After \ build \ is \ complete \ the \ generated \ images \ can \ be \ found \ in \ yocto-layers/build/arago-tmp-external-linaro-toolchain/deploy/images/dra7xx-hs-evm$

Generated images

Image name	Description	
tisdk-rootfs-image-dra7xx-hs-evm- < <i>DATE</i> >.rootfs.tar.xz	This is the filesystem tarball. Copy and extract it on the rootfs partition of the boot media.	
u-boot-< <i>MACHINE-NAME</i> >.img	Copy as u-boot.img in boot partition.	
MLO-< <i>MACHINE-NAME</i> >	Copy as MLO in boot partition.	

Note 1 (fitImage.itb): The yocto build does not generate the FIT image incorporating signed Linux kernel zImage, signed DTB files, and OP-TEE OS image. This file must be generated manually using the command below and copied to /boot of rootfs partition.

host \$ cd \$PSDKLA_INSTALL_DIR/yocto-layers/build/arago-tmp-external-linaro-toolchain/work/dra7xx_hs_evm-linux-gnueabi/linux-ti-staging/<*VERSION*>/build host \$ mkimage -f fit-image.its fitImage.itb

Note 2 (uenv.txt): The build does not generate a uenv.txt. You need to copy it from the prebuilt binaries in the release to boot partition. The following line must be added to boot fitImage.itb for SD card boot:

mcboot=run update_to_fit;run args_mmc;run loadimage;bootm \${loadaddr}#\${fdtfile}

OP-TEE Trusted execution environment

Processor SDK Linux Automotive supports OP-TEE (https://github.com/OP-TEE/optee_os), a open-source, GlobalPlatform compliant Trusted Execution Environment. OP-TEE components are integrated into the SDK and will be available as a out-of-the-box demo.

- 1. OP-TEE OS is built as a binary image, signed and included in fitImage.itb to be loaded by u-boot.
- 2. OP-TEE linux driver is included in TI baseline Linux kernel in SDK.
- 3. OP-TEE client library and tee-supplicant (userspace components) are included in the SDK filesystem. tee-supplicant daemon is launched into background by default.

Testing OP-TEE

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The SDK filesystem includes the xtest consolidated testing tool from OP-TEE. Running this application with no arguments executes the full test suite and prints out the results, which must look like this:

	Keystone=	C2000=For	MAVRK=For	
0 test case was skipped TEE test application done!			 	
23519 subtests of which 0 failed 69 test cases of which 0 failed				
ľ				- 1

- 1. switchcategory:MultiCore=
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